

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

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FFP20UP20DN Ultrafast Recovery Power Rectifier

Features

• Ultrafast with Soft Recovery : < 45ns

• High Reverse Voltage : V_{RRM} = 200V

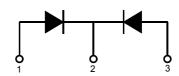
- · Avalanche Energy Rated
- · Planar Construction

Applications

- · Output Rectifiers
- · Switching Mode Power Supply
- · Free-wheeling diode for motor application
- · Power switching circuits



1.Anode 2.Cathode 3.Anode



1. Anode 2. Cathode 3. Anode

Absolute Maximum Ratings (per diode) T_a = 25°C unless otherwise noted

Symbol	Parameter	Value	Units
V _{RRM}	Peak Repetitive Reverse Voltage	200	V
V _{RWM}	Working Peak Reverse Voltage	200	V
V _R	DC Blocking Voltage	200	V
I _{F(AV)}	Average Rectified Forward Current @ T _C = 120°C	10	Α
I _{FSM}	Non-repetitive Peak Surge Current 60Hz Single Half-Sine Wave	100	Α
T _J , T _{STG}	Operating Junction and Storage Temperature	- 65 to +150	°C

Thermal Characteristics T_a = 25°C unless otherwise noted

Symbol	Parameter	Max	Units
$R_{\theta JC}$	Maximum Thermal Resistance, Junction to Case	3.0	°C/W

Electrical Characteristics (per diode) T_a = 25°C unless otherwise noted

Symbol	Parameter		Min.	Тур.	Max.	Units
V _{FM} *	I _F = 10A I _F = 10A	T _C = 25 °C T _C = 150 °C	-	-	1.15 1.0	V V
I _{RM} *	V _R = 200V V _R = 200V	T _C = 25 °C T _C = 150 °C	-	-	100 500	μ Α μ Α
t _{rr}	I_F =1A, di/dt = 100A/ μ s, V_{CC} = 30V I_F =10A, di/dt = 200A/ μ s, V_{CC} = 130V	T _C = 25 °C T _C = 25 °C	-	-	35 45	ns ns
t _a t _b Q _{rr}	I_F =10A, di/dt = 200A/ μ s, V_{CC} = 130V	$T_C = 25 ^{\circ}C$ $T_C = 25 ^{\circ}C$ $T_C = 25 ^{\circ}C$	- - -	15 12 36	- - -	ns ns nC
W _{AVL}	Avalanche Energy (L = 20mH)	•	10	-	-	mJ

 $^{^{\}star}$ Pulse Test: Pulse Width=300 $\mu\text{s},$ Duty Cycle=2%

Typical Performance Characteristics

Figure 1. Typical Forward Voltage Drop

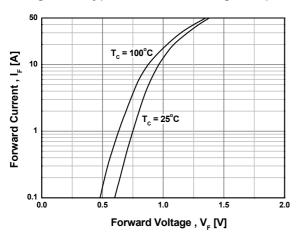


Figure 2. Typical Reverse Current

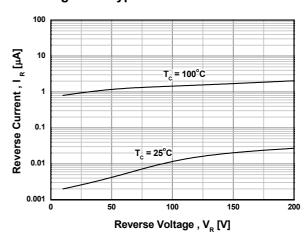


Figure 3. Typical Junction Capacitance

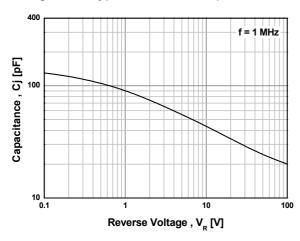


Figure 4. Typical Reverse Recovery Time

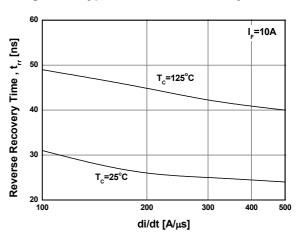


Figure 5. Typical Reverse Recovery Current

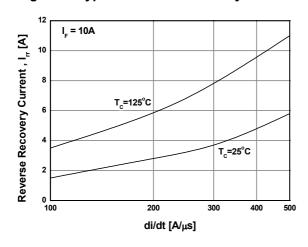
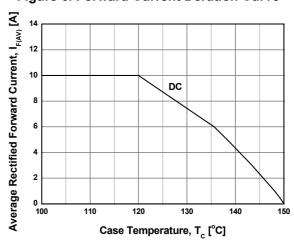
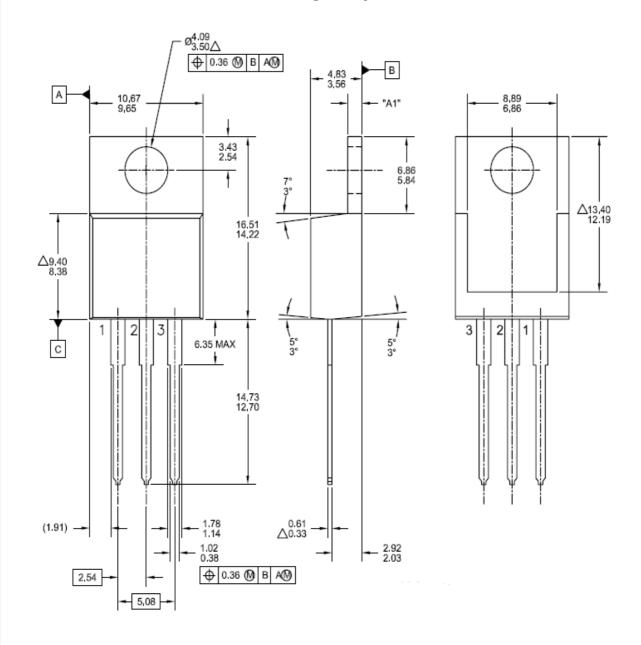


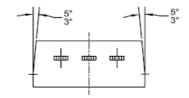
Figure 6. Forward Current Deration Curve



Mechanical Dimensions

TO - 220





Dimensions in Millimeters

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Programmable Active Droop™		Power247™	Stealth™	

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